

## Application Data Sheet

### Application Information

Application Type:: Regular  
Subject Matter:: Utility  
Suggested Classification::  
Suggested Group Art Unit::  
CD-ROM or CD-R?:: None  
Number of CD disks::  
Number of Copies of CDs::  
Sequence Submission?:: None  
Computer Readable Form (CRF):: No  
Number of copies of CRF:: 0  
Title:: SEMICONDUCTOR DEVICE CAPABLE OF  
PREVENTING SOLDER BALLS FROM  
BEING REMOVED IN REINFORCING  
PAD  
Attorney Docket Number:: 8037-1001  
Request for Early  
Publication?:: No  
Request for Non-Publication?:: No  
Suggested Drawing Figure::  
Total Drawing Sheets:: 5  
Small Entity?:: No  
Latin Name::  
Variety Denomination Name::  
Petition Included?:: No  
Petition Type::  
Licensed US Gov't Agency::  
Contract or Grant Numbers::  
Secrecy Order in Parent No  
Appl.?::

**Applicant Information**

Applicant Authority Type:: Inventor  
Primary Citizenship Country:: JAPAN  
Status:: Full Capacity  
Given Name:: KIMIO  
Middle Name::  
Family Name:: TSUNEMASU  
City of Residence:: TOKYO  
State or Province of Residence::  
Country of Residence:: JAPAN  
Street of Mailing Address:: 7-1, SHIBA 5-CHOME  
City of Mailing Address:: TOKYO  
State or Province of Mailing Address:: MINATO-KU  
Country of Mailing Address:: JAPAN  
Postal or Zip Code of Mailing Address::

**Correspondence Information**

Correspondence Customer Number:: 000466

**Representative Information**

Representative Customer Number::	000466
----------------------------------	--------

**Domestic Priority Information**

Application::	Continuity Type::	Parent Application::	Parent Filing Date::

**Foreign Priority Information**

Country::	Application Number::	Filing Date::	Priority Claimed::
JAPAN	2001-034793	2/13/01	Yes

**Assignment Information**

Assignee Name:: NEC CORPORATION  
Street of Mailing 7-1, SHIBA 5-CHOME  
Address::  
City of Mailing Address:: TOKYO  
State or Province of Mailing Address:: MINATO-KU  
Country of Mailing Address:: JAPAN  
Postal or Zip Code of Mailing Address::